

L Number	Hits	Search Text	DB	Time stamp
5	19	(US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$).did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.	USPAT; US-PGPUB	2004/11/01 14:43
6	10	((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$).did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and customer	USPAT; US-PGPUB	2004/11/01 14:43
7	5	((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$).did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and customer) and MES	USPAT; US-PGPUB	2004/11/01 15:18
8	0	((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$).did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and team	USPAT; US-PGPUB	2004/11/01 15:18
9	14	((US-5834915-\$ or US-6725113-\$ or US-6603529-\$ or US-6240335-\$ or US-6760640-\$ or US-6748287-\$ or US-6529789-\$ or US-6618640-\$ or US-5841660-\$ or US-5751581-\$ or US-6366824-\$ or US-6148307-\$).did. or (US-20040049398-\$ or US-20020044266-\$ or US-20040088068-\$ or US-20020116083-\$ or US-20010047222-\$ or US-20040214097-\$ or US-20030233161-\$).did.) and operator	USPAT; US-PGPUB	2004/11/01 15:20
-	1	6537844.pn.	USPAT; US-PGPUB	2004/10/29 15:40
-	367	mask and semiconductor and track and state adj diagram	USPAT; US-PGPUB	2004/09/09 13:52
-	0	(mask and semiconductor and track and state adj diagram) and virtual adj fab	USPAT; US-PGPUB	2004/09/09 13:51
-	87	(mask and semiconductor and track and state adj diagram) and virtual	USPAT; US-PGPUB	2004/09/09 13:51
-	14	((mask and semiconductor and track and state adj diagram) and virtual) and future same location	USPAT; US-PGPUB	2004/09/09 13:51
-	0	mask same lithographic and semiconductor and track and state adj diagram	USPAT; US-PGPUB	2004/09/09 13:52
-	13	mask same semiconductor and track and state adj diagram	USPAT; US-PGPUB	2004/09/09 13:52
-	5	5834915.URPN.	USPAT	2004/09/09 13:57
-	1	6537844.pn.	USPAT; US-PGPUB	2004/10/22 14:37

-	648	semiconductor and mask and future SAME location	USPAT; US-PGPUB	2004/10/22 14:41
-	65	(semiconductor and mask and future SAME location ) and fab	USPAT; US-PGPUB	2004/10/22 14:41
-	5	((semiconductor and mask and future SAME location ) and fab) and reticle	USPAT; US-PGPUB	2004/10/22 14:43
-	50	((semiconductor and mask and future SAME location ) and fab) and track\$3	USPAT; US-PGPUB	2004/10/22 14:44
-	52	(reticle or mask) same track\$3 and fab	USPAT; US-PGPUB	2004/10/22 14:47
-	47	((reticle or mask) same track\$3 and fab) and process) and location	USPAT; US-PGPUB	2004/10/22 14:48
-	52	((reticle or mask) same track\$3 and fab) and process	USPAT; US-PGPUB	2004/10/22 15:10
-	82	kosowski.xa.	USPAT; US-PGPUB	2004/10/22 15:30
-	185	700/115.ccls.	USPAT; US-PGPUB	2004/10/22 15:30
-	0	700/115.ccls. and virtual same fab	USPAT; US-PGPUB	2004/10/22 15:30
-	72	700/115.ccls. and tracking	USPAT; US-PGPUB	2004/10/22 15:31
-	25	(700/115.ccls. and tracking) and (semiconductor or reticle or mask)	USPAT; US-PGPUB	2004/10/22 15:41
-	1	virtual adj fab	USPAT; US-PGPUB	2004/10/22 15:41
-	545	semiconductor and track same predict\$4	USPAT; US-PGPUB	2004/10/22 16:15
-	15	state adj diagram and reticle	USPAT; US-PGPUB	2004/10/22 16:18
-	1685	state adj diagram and mask	USPAT; US-PGPUB	2004/10/22 16:18
-	413	(state adj diagram and mask) and semiconductor and track\$3	USPAT; US-PGPUB	2004/10/22 16:19
-	32	((state adj diagram and mask) and semiconductor and track\$3) and fab	USPAT; US-PGPUB	2004/10/22 16:35
-	8	enterprise same mask same management	USPAT; US-PGPUB	2004/10/22 16:55
-	7	700/115.ccls. and enterprise	USPAT; US-PGPUB	2004/10/22 16:58
-	4	virtual adj fabrication	USPAT; US-PGPUB	2004/10/22 16:58
-	15	state adj diagram and reticle	USPAT; US-PGPUB	2004/10/25 11:53
-	115	700/\$.ccls. and track same semiconductor	USPAT; US-PGPUB	2004/10/27 16:38
-	26	(700/\$.ccls. and track same semiconductor) and customer	USPAT; US-PGPUB	2004/10/27 16:38
-	14	((700/\$.ccls. and track same semiconductor) and customer) and fabrication	USPAT; US-PGPUB	2004/10/27 16:43
-	1339	700/115,121,222,229.ccls.	USPAT; US-PGPUB	2004/10/27 16:39
-	167	700/115,121,222,229.ccls. and reticle	USPAT; US-PGPUB	2004/10/29 15:44
-	28	(700/115,121,222,229.ccls. and reticle) and station and track\$4	USPAT; US-PGPUB	2004/10/27 16:45
-	1	6760640.pn.	USPAT; US-PGPUB	2004/10/27 16:48
-	1	6148307.pn.	USPAT; US-PGPUB	2004/10/27 16:48
-	4	virtual adj fabrication	USPAT; US-PGPUB	2004/10/29 15:41
-	1	virtual adj fab	USPAT; US-PGPUB	2004/10/29 15:42
-	632	lithograph\$3 and virtual and track\$3	USPAT; US-PGPUB	2004/10/29 15:42
-	21	(lithograph\$3 and virtual and track\$3) and enterprise	USPAT; US-PGPUB	2004/10/29 15:42
-	363	700/115,121,222,229.ccls. and mask	USPAT; US-PGPUB	2004/10/29 15:44

-	6	700/115,121,222,229.ccls. and lithographic adj mask	USPAT; US-PGPUB	2004/10/29 15:44
-	0	track with lithographic adj mask	USPAT; US-PGPUB	2004/10/29 15:44
-	5	track same lithographic adj mask	USPAT; US-PGPUB	2004/10/29 15:45
-	11	track\$3 same lithographic adj mask	USPAT; US-PGPUB	2004/10/29 15:45
-	205	track\$3 same mask same semiconductor	USPAT; US-PGPUB	2004/10/29 15:45
-	6	(track\$3 same mask same semiconductor) and virtual	USPAT; US-PGPUB	2004/10/29 15:46
-	12	(track\$3 same mask same semiconductor) and customer	USPAT; US-PGPUB	2004/10/29 15:47
-	1080	(semiconductor or wafer or substrate) same track\$3 and virtual	USPAT; US-PGPUB	2004/10/29 15:48
-	27	((semiconductor or wafer or substrate) same track\$3 and virtual) and future same location	USPAT; US-PGPUB	2004/10/29 15:47
-	885	(semiconductor or wafer or substrate) same track\$3 and customer	USPAT; US-PGPUB	2004/10/29 15:49
-	752	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)	USPAT; US-PGPUB	2004/10/29 15:49
-	365	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)) and manufacturer	USPAT; US-PGPUB	2004/10/29 15:49
-	239	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)) and manufacturer) and interface	USPAT; US-PGPUB	2004/10/29 15:49
-	29	((semiconductor or wafer or substrate) same track\$3 and customer) and (fabricat\$3 or manufactur\$3)) and manufacturer) and interface) and enterprise	USPAT; US-PGPUB	2004/10/29 15:49